



MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model : MI0970AT-1

For Customer's Acceptance:

Customer	
Approved	
Comment	

Revision	2.1
Engineering	
Date	2012-02-22
Our Reference	





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**■ GENERAL INFORMATION**

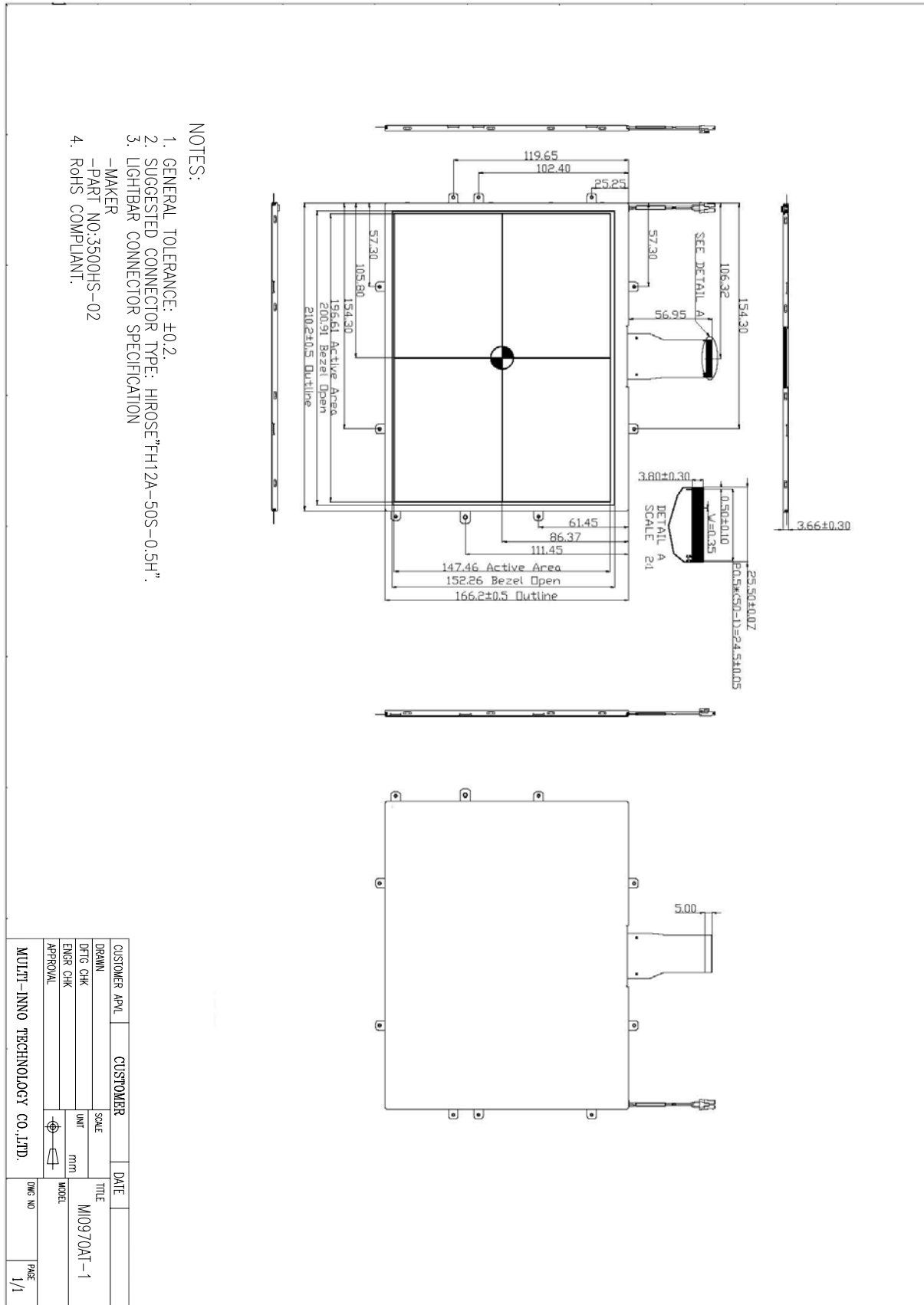
Item	Contents	Unit
LCD type	TFT/Transmissive/Normally white	/
Size	9.7	Inch
Viewing direction	3:00	O' Clock
Gray scale inversion direction	9:00	O' Clock
LCM (W × H × D)	210.20×166.20×3.66	mm ³
Active area (W×H)	196.608×147.456	mm ²
Pixel pitch (W×H)	0.192×0.192	mm ²
Number of dots	1024 (RGB) × 768	/
Backlight type	36 LEDs	/
Interface type	RGB 24 bits with TCON	/
Color depth	16.7M	/
Pixel configuration	R.G.B vertical stripe	/
Surface treatment(Up polarizer)	Anti glare(3H)	/
Input voltage	3.3	V
With/Without TSP	Without TSP	/
Weight	TBD	g

Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2 : RoHS compliant;

Note 3: LCM weight tolerance: ± 5% .

EXTERNAL DIMENSIONS



■ ABSOLUTE MAXIMUM RATINGS

Parameter of absolute maximum ratings	Symbol	Min	Max	Unit
Power supply voltage	DVDD	-0.3	5.0	V
	AVDD	-0.5	13.5	V
	VGH	-0.3	+42	V
	VGL	VGH-42	+0.3	V
Operating temperature	Top	-20	70	°C
Storage temperature	TST	-30	80	°C
Humidity	RH	-	90%(Max60 °C)	RH

■ ELECTRICAL CHARACTERISTICS

Recommended Operating Condition

Parameter of DC characteristics	Symbol	Min	Typ	Max	Unit
Digital supply voltage	DVCC	3.0	3.3	3.6	V
Gate on voltage	VGH	20.8	22	23.3	V
Gate off voltage	VGL	-7.5	-7.0	-6.5	V
Analog supply voltage	AVDD	12.3	12.5	12.7	V
VCOM	VCOM	-	-	-	V

Power Consumption

AGND=GND=0V, Ta = 25°C

Item	Symbol	Condition	Min	Typ	Max	Unit	Remark
Digital Supply Current	I _{DVDD}	DVDD=3.3V	-	TBD	TBD	mA	
Analog Supply Current	I _{AVDD}	AVDD=12.5V	-	TBD	TBD	mA	
Gate On Current	I _{VGH}	VGH=22V	-	TBD	TBD	mA	
Gate Off Current	I _{VGL}	VGL=-7.0V	-	TBD	TBD	mA	
Power Consumption	Panel&Gamma		-	TBD	TBD	mW	
	Backlight		-	TBD	TBD	W	
	Total		-	TBD	TBD	W	

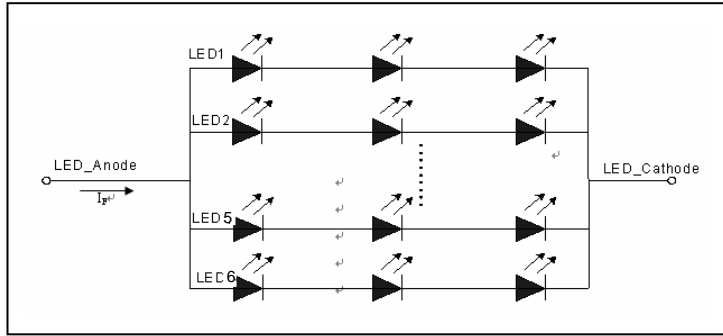
■ BACKLIGHT CHARACTERISTICS

Item of backlight characteristics	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward voltage	V _f	-	19.2	-	V	If=120mA,Ta=25°C
Number of LED	-	-	6*6	-	Piece	-
Operating life time	-	-	30000	-	Hrs	

Note1: For each LED: I_F (1/6) =20mA, V_F (1/6) =3.2V.

Note2: Under LCM operating, the stable forward current should be inputted. And forward voltage is for reference only.

Note3: I_F is defined for one channel LED. Optical performance should be evaluated at Ta=25°C only. If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced. Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.



Note4: The LED driving condition is defined for each LED module.

■ ELECTRO-OPTICAL CHARACTERISTICS

Item of electro-optical characteristics	Symbol	Condition	Min	Typ	Max	Unit	Remark	Note
Response time	Tr+ Tf	$\theta=0^\circ$ $\phi=0^\circ$ $T_a=25^\circ\text{C}$	-	40	-	ms	Fig.1	4
Contrast ratio	Cr		-	500	-	---	FIG 2.	1
Luminance uniformity	δ WHITE		-	75	-	%	FIG 2.	3
Surface Luminance	Lv		-	220	-	cd/m ²	FIG 2.	2
Viewing angle range	θ	$\phi = 90^\circ$	-	70	-	deg	FIG 3.	6
		$\phi = 270^\circ$	-	70	-	deg	FIG 3.	
		$\phi = 0^\circ$	-	60	-	deg	FIG 3.	
		$\phi = 180^\circ$	-	70	-	deg	FIG 3.	
NTSC ratio	---	---	-	50	-	%	-	-
CIE (x, y) chromaticity	Red x	$\theta=0^\circ$ $\phi=0^\circ$ $T_a=25^\circ\text{C}$	-	-	-	-	FIG 2.	5
	Red y		-	-	-	-		
	Green x		-	-	-	-		
	Green y		-	-	-	-		
	Blue x		-	-	-	-		
	Blue y		-	-	-	-		
	White x		-	0.313	-	-		
	White y		-	0.329	-	-		

Note1. Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG 2.:

$$\text{Contrast Ratio} = \frac{\text{Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5)}}$$

Note2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

$$L_v = \text{Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}$$

Note3. The uniformity in surface luminance (δ WHITE) is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

$$\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Maximum Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}$$

Note4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1..

Note5. CIE (x, y) chromaticity, The x,y value is determined by screen active area position 5. For more information see FIG 2.

- Note6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.
- Note7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on TOPCON's BM-5 photo detector.
- Note8. For TFT transmissive module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time

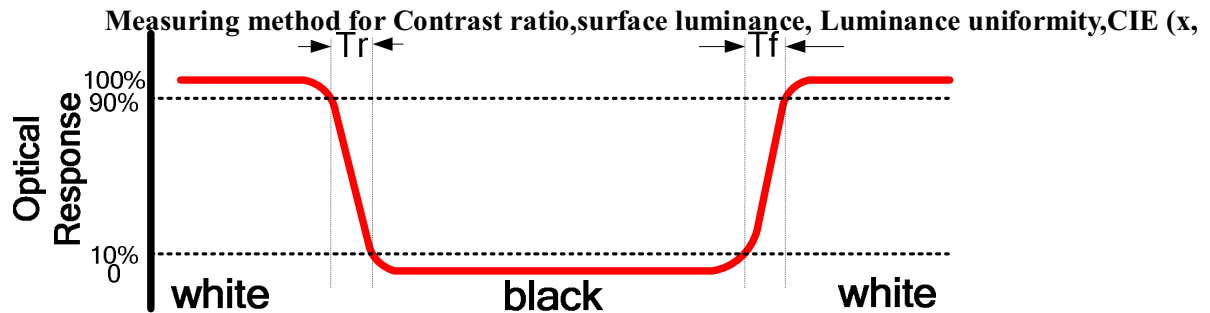


FIG.2.
y) chromaticity

A : 5 mm
B : 5 mm
H, V : Active Area
Light spot size $\varnothing=5\text{mm}$, 500mm distance from the LCD surface to detector lens
measurement instrument is TOPCON's luminance meter BM-5

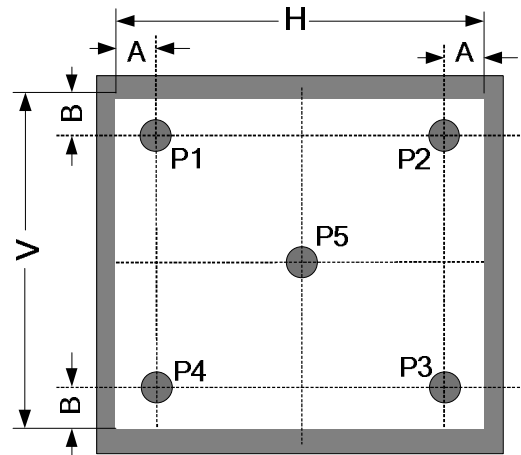
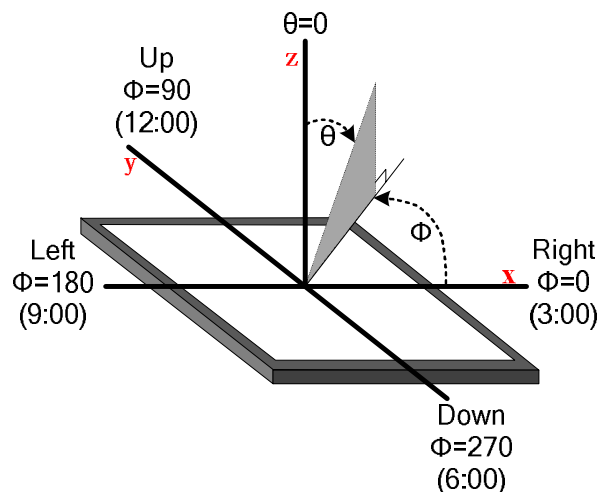


FIG.3. The definition of viewing angle



■ INTERFACE DESCRIPTION

1.1 CN1 of FPC

Pin No.	Symbol	I/O	Function	Remarks
1	NC	-	No connection	-
2	CABC_EN1	-	-	-
3	CABC_EN0	-	-	-
4	DIMO	-	-	-
5	GND	P	Power ground	-
6	VCOM	I	Common voltage	-
7	DVDD	P	Power supply 3.3V	-
8	MODE	I	DE/SYNC mode select	MODE=1, DE mode; MODE=0, HSD/VSD mode.
9	DE	I	Data input enable	-
10	VS	I	Vertical sync input	-
11	HS	I	Horizontal sync Input	-
12	B7	I	Blue data (MSB)	-
13	B6	I	Blue data	-
14	B5	I	Blue data	-
15	B4	I	Blue data	-
16	B3	I	Blue data	-
17	B2	I	Blue data	-
18	B1	I	Blue data	-
19	B0	I	Blue data (LSB)	-
20	G7	I	Green data (MSB)	-
21	G6	I	Green data	-
22	G5	I	Green data	-
23	G4	I	Green data	-
24	G3	I	Green data	-
25	G2	I	Green data	-
26	G1	I	Green data	-
27	G0	I	Green data (LSB)	-
28	R7	I	RED data (MSB)	-
29	R6	I	RED data	-
30	R5	I	RED data	-
31	R4	I	RED data	-
32	R3	I	RED data	-
33	R2	I	RED data	-
34	R1	I	RED data	-
35	R0	I	RED data (LSB)	-
36	GND	P	Power ground	-
37	DCLK	I	Clock for input data	-
38	GND	P	Power ground	-
39	L/R	I	Left/right scan selection	L/R=1, from left to right; L/R=0, from right to left.
40	U/D	I	Up/down selection	U/D=0, from up to down; U/D=1, from down to up.

41	VGH	P	Gate on voltage	-
42	VGL	P	Gate off voltage	-
43	AVDD	P	Power for analog circuit	-
44	RESET	I	Global reset pin	-
45	NC	-	No connection	-
46	VCOM	I	Common voltage	-
47	DITHB	I	Dithering function	DITHB=1, Disable internal dithering function; DITHB=0, Enable internal dithering function
48	GND	P	Power ground	-
49	NC	-	No connection	-
50	NC	-	No connection	-

Note: I/O definition.

I---Input pin, O---Output pin, P--- Power/Ground, N--- No Connection

1.2 U/D R/L Function Description

Scan Control Input		Scanning Direction
UPDN	SHLR	
GND	DVDD	Up to Down, Left to Right
DVDD	GND	Down to Up, Right to Left
GND	GND	Up to Down, Right to Left
DVDD	DVDD	Down to Up, Left to Right

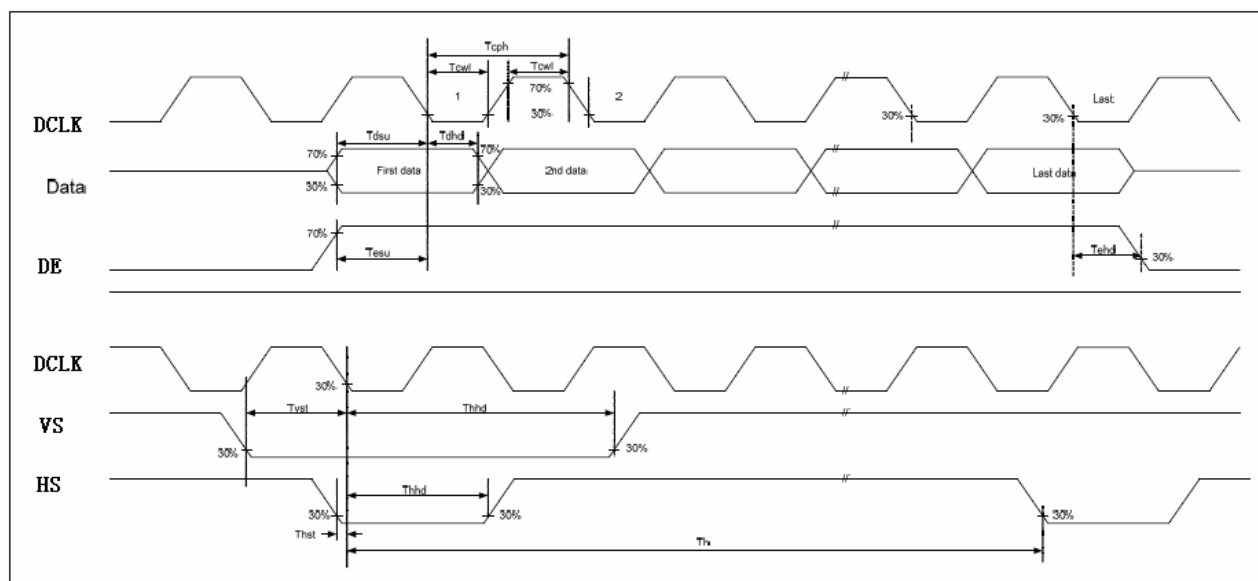
■ REFERENCE APPLICATION NOTES

2.1 TFT-LCD Input Timing

DVDD=3.3V, AVDD=10.4V, AGND=GND=0V, Ta=25℃

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
DCLK Cycle Time	Tcph	14	-	-	ns	
DCLK Pulse Width	Tcwh	40	50	60	%	
VSD Setup Time	Tvst	5	-	-	ns	
VSD Hold Time	Tvhd	5	-	-	ns	
HSD Setup Time	Thst	5	-	-	ns	
HSD Hold Time	Thhd	5	-	-	ns	
Data Setup Time	Tdsu	5	-	-	ns	Data to DCLK
Data Hold Time	Tdhd	5	-	-	ns	Data to DCLK
DE Setup Time	Tesu	5	-	-	ns	
DE Hold Time	Tehd	5	-	-	ns	

Input Clock and Data timing Diagram:



2.2 Recommended Timing Setting Of TCON

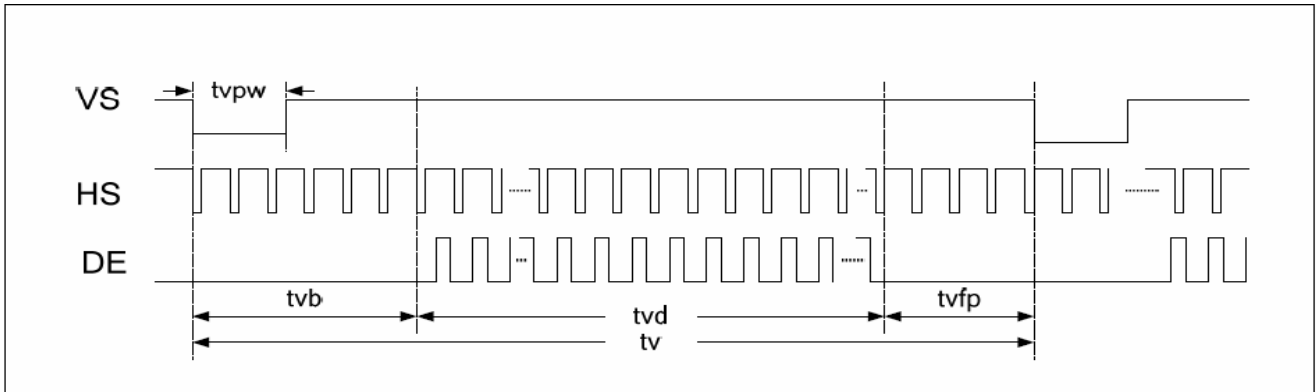
TCON (Embedded In Source IC) Input Timing (DCLK, HSD, VSD, DE)

DVDD=3.3V, AVDD=10.4V, AGND=GND=0V, Ta=25°C

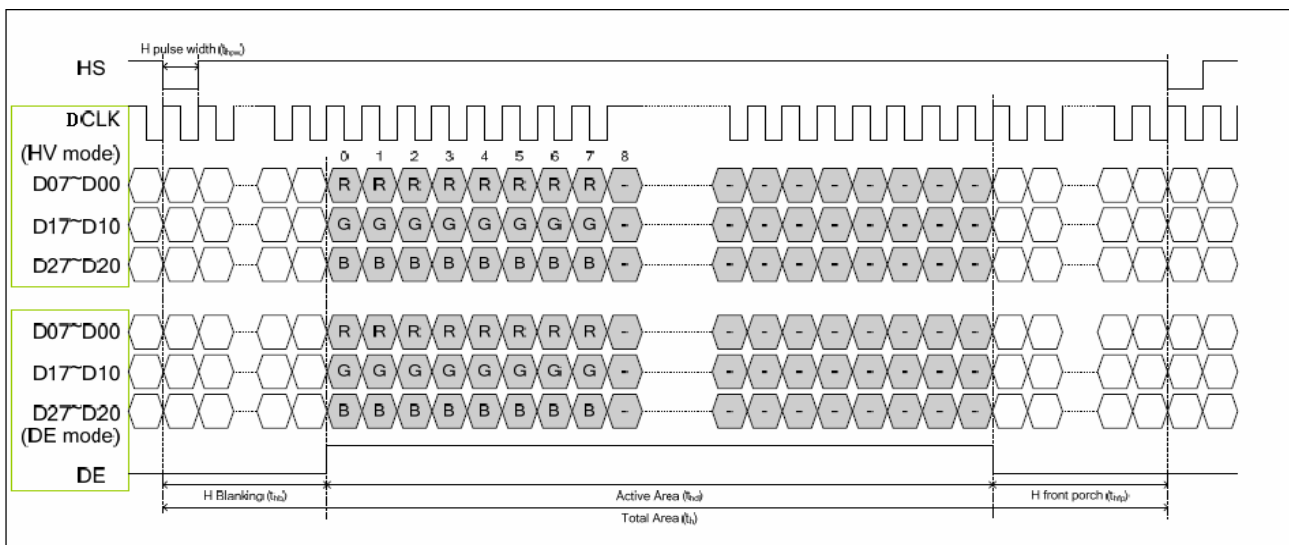
Parameter	Symbol	Min	Typ	Max	Unit	Remark
DCLK	Fclk	-	65	-	MHZ	
HSD	th	-	1344	-	tclk	
	thd	-	1024	-	tclk	
	thpw	1	-	140	tclk	
	thb	-	160	-	tclk	
	thfp	-	160	-	tclk	
VSD	tv	-	806	-	th	
	tvd	-	768	-	th	
	tvpw	1	-	20	th	
	tvb	-	23	-	th	
	tvfp	-	15	-	th	

Note: DE timing refer to HSD, VSD input timing.

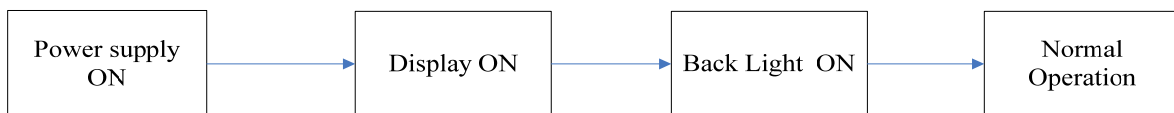
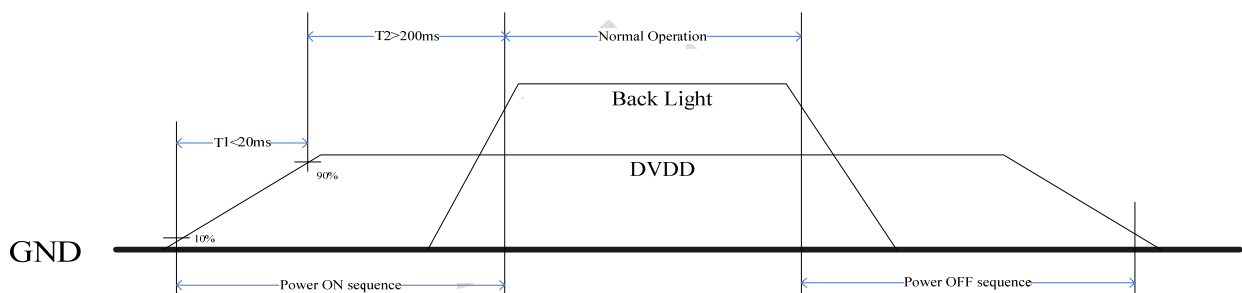
Vertical input timing Diagram:



Horizontal input timing Diagram:



2.3 POWER ON/OFF SEQUENCE



Power ON Sequence



Power OFF Sequence

**■ RELIABILITY TEST CONDITIONS**

No.	Test Item	Test Condition	Remark
1	High Temperature Storage	$80 \pm 2^{\circ}\text{C}/240$ hours	IEC60068-2-1 GB2423.2
2	Low Temperature Storage	$-30 \pm 2^{\circ}\text{C}/240$ hours	IEC60068-2-1 GB2423.1
3	High Temperature Operating	$70 \pm 2^{\circ}\text{C}/240$ hours	IEC60068-2-1 GB2423.2
4	Low Temperature Operating	$-20 \pm 2^{\circ}\text{C}/240$ hours	IEC60068-2-1 GB2423.1
5	Temperature Cycle storage	$-30 \pm 2^{\circ}\text{C} \sim 25 \sim 80 \pm 2^{\circ}\text{C} \times 20$ cycles (30min.) (5min.) (30min.)	Start with cold temperature, with high temperature, IEC60068-2-14 GB2423.22
6	Damp proof Test operating	$60^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%\text{RH}/240$ hours	IEC60068-2-78 GB/T2423.3
7	Vibration Test (non-operation)	Frequency range:10Hz~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2hours for each direction of X,Y,Z(6 hours for total)	IEC60068-2-6 GB/T2423.10
8	Package drop test	Height:80 cm,1 corner,3 edges,6 surfaces	IEC60068-2-32,GB2423.8
9	ESD test (operation)	C=150pF,R=330 Ω ,5points/panel Air: $\pm 8\text{KV}$,5times Contact: $\pm 4\text{KV}$,5times(Environment: $15^{\circ}\text{C} \sim 35^{\circ}\text{C}$,30%~60%,86Kpa~106Kpa)	IEC61000-4-2 GB/T17626.2
10	Shock(non-operation)	60G 6ms, $\pm X, \pm Y, \pm Z$ 3times each direction	IEC60068-2-27 GB/T2423.5

Note 1:Ts is the temperature of panel's surface.

Note 2:Ta is the ambient temperature of sample.

■ INSPECTION CRITERION

This specification is made to be used as the standard acceptance/rejection criteria for Normal LCM Product.

1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65

Minor defect: AQL 1.5

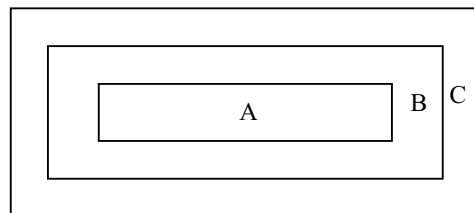
2. Inspection condition

● Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature 20~25°C and normal humidity 60±15%RH).

● Driving voltage

The Vop value from which the most optimal contrast can be obtained near the specified Vop in the specification (Within ±0.5V of the typical value at 25°C.).

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

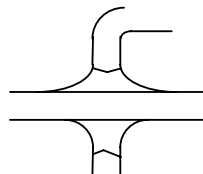
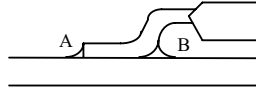
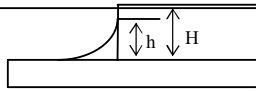
4. Inspection Standard

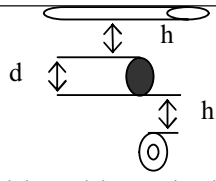
4.1 Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1.1	All functional defects	1) No display 2) Display abnormally 3) Missing vertical, horizontal segment 4) Short circuit 5) Back-light no lighting, flickering and abnormal lighting.	Major
4.1.2	Missing	Missing component	
4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	

4.2 Cosmetic Defect

4.2.1 Module Cosmetic Criteria

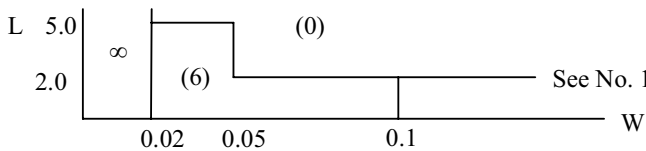
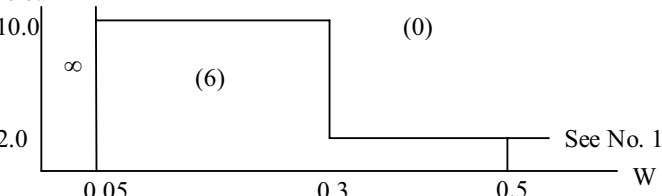
No.	Item	Judgement Criterion	Partition
1	Difference in Spec.	None allowed	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
3	Soldering defects	No soldering missing No soldering bridge No cold soldering	Major Major Minor
4	Resist flaw on Printed Circuit Boards	visible copper foil ($\varnothing 0.5\text{mm}$ or more) on substrate pattern	Minor
5	Accretion of metallic Foreign matter	No accretion of metallic foreign matters (Not exceed $\varnothing 0.2\text{mm}$)	Minor Minor
6	Stain	No stain to spoil cosmetic badly	Minor
7	Plate discoloring	No plate fading, rusting and discoloring	Minor
8	Solder amount 1. Lead parts	a. Soldering side of PCB Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly. (too much) b. Components side (In case of 'Through Hole PCB')  Solder to reach the Components side of PCB.	Minor
	2. Flat packages	Either 'Toe' (A) or 'Seal' (B) of the lead to be covered by 'Filet'.  Lead form to be assume over solder.	Minor
	3. Chips	$(3/2) H \geq h \geq (1/2) H$ 	Minor

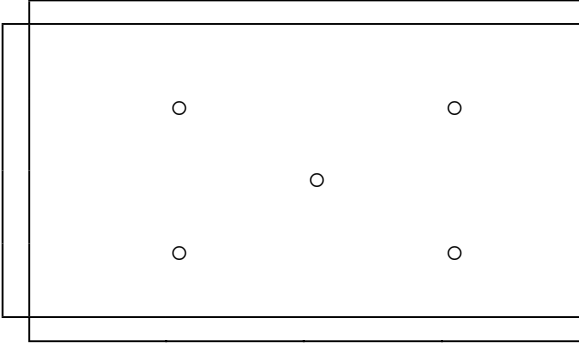
9	Solder splash	ball/Solder	<p>a. The spacing between solder ball and the conductor or solder pad $h \geq 0.13\text{mm}$ The diameter of solder ball $d \leq 0.15\text{mm}$.</p> <p>b. The quantity of solder balls or solder Splashes isn't beyond 5 in 600mm^2.</p> <p>c. Solder balls/Solder splashes do not violate minimum electrical clearance.</p> <p>d. Solder balls/Solder splashes must be entrapped/encapsulated Or attached to the metal surface .</p> <p>NOTE: Entrapped/encapsulated/attached is intended to mean that normal service environment of the product will not cause a solder ball to become dislodged.</p>		Minor	Minor	Major	Minor
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4.2.2Cosmetic Criteria (Non-Operating)

LCD Cosmetic Criteria (Non-Operating)													
No.	Defect	Judgment Criterion	Partition										
1	Spots	In accordance with <i>Screen Cosmetic Criteria (Operating) No.1.</i>	Minor										
2	Lines	In accordance with <i>Screen Cosmetic Criteria (Operating) No.2.</i>	Minor										
3	Bubbles in polarizer	<table><tr><th>Size : d mm</th><th>Acceptable Qty in active area</th></tr><tr><td>d ≤ 0.3</td><td>Disregard</td></tr><tr><td>0.3 < d ≤ 1.0</td><td>3</td></tr><tr><td>1.0 < d ≤ 1.5</td><td>1</td></tr><tr><td>1.5 < d</td><td>0</td></tr></table>	Size : d mm	Acceptable Qty in active area	d ≤ 0.3	Disregard	0.3 < d ≤ 1.0	3	1.0 < d ≤ 1.5	1	1.5 < d	0	Minor
Size : d mm	Acceptable Qty in active area												
d ≤ 0.3	Disregard												
0.3 < d ≤ 1.0	3												
1.0 < d ≤ 1.5	1												
1.5 < d	0												
4	Scratch	In accordance with spots and lines operating cosmetic criteria. When the light reflects on the panel surface, the scratches are not to be remarkable.	Minor										
5	Allowable density	Above defects should be separated more than 30mm each other.	Minor										
6	Coloration	Not to be noticeable coloration in the viewing area of the LCD panels. Back-lit type should be judged with back-lit on state only.	Minor										
7	Contamination	Not to be noticeable.	Minor										

4.2.3 Cosmetic Criteria (Operating)

No.	Defect	Judgment Criterion	Partition																																												
1	Spots	<div>A) Clear</div> <table><thead><tr><th>Lcd size</th><th>Size : d mm</th><th>Acceptable Qty in active area</th></tr></thead><tbody><tr><td rowspan="4">Lcd size≤8.0'</td><td>d≤0.1</td><td>Disregard</td></tr><tr><td>0.1<d≤0.2</td><td>6</td></tr><tr><td>0.2<d≤0.3</td><td>2</td></tr><tr><td>0.3<d</td><td>0</td></tr><tr><td rowspan="4">Lcd size>8.0'</td><td>d≤0.1</td><td>Disregard</td></tr><tr><td>0.1<d≤0.3</td><td>10</td></tr><tr><td>0.3<d≤0.5</td><td>5</td></tr><tr><td>0.5<d</td><td>0</td></tr></tbody></table> <div>Note : Including pin holes and defective dots which must be within one pixel size; Total defective point shall not exceed 6 pcs no more than 8 inch LCD and 10PCS for more than 8 inch LCD.</div> <div>B) Unclear</div> <table><thead><tr><th>Lcd size</th><th>Size : d mm</th><th>Acceptable Qty in active area</th></tr></thead><tbody><tr><td rowspan="4">Lcd size≤8.0'</td><td>d≤0.2</td><td>Disregard</td></tr><tr><td>0.2<d≤0.5</td><td>6</td></tr><tr><td>0.5<d≤0.7</td><td>2</td></tr><tr><td>0.7<d</td><td>0</td></tr><tr><td rowspan="5">Lcd size >8.0'</td><td>d≤0.2</td><td>Disregard</td></tr><tr><td>0.2<d≤0.5</td><td>10</td></tr><tr><td>0.5<d≤0.7</td><td>3</td></tr><tr><td>0.7<d≤1.0</td><td>1</td></tr><tr><td>1.0<d</td><td>0</td></tr></tbody></table> <div>Note : Total defective point shall not exceed 6 pcs for no more than 8 inch LCD and 10PCS for more than 8 inch LCD.</div>	Lcd size	Size : d mm	Acceptable Qty in active area	Lcd size≤8.0'	d≤0.1	Disregard	0.1<d≤0.2	6	0.2<d≤0.3	2	0.3<d	0	Lcd size>8.0'	d≤0.1	Disregard	0.1<d≤0.3	10	0.3<d≤0.5	5	0.5<d	0	Lcd size	Size : d mm	Acceptable Qty in active area	Lcd size≤8.0'	d≤0.2	Disregard	0.2<d≤0.5	6	0.5<d≤0.7	2	0.7<d	0	Lcd size >8.0'	d≤0.2	Disregard	0.2<d≤0.5	10	0.5<d≤0.7	3	0.7<d≤1.0	1	1.0<d	0	Minor
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2	Lines	<div>A) Clear</div> <div></div> <div>Note : () - Acceptable Qty in active area L - Length (mm) W - Width (mm) ∞ - Disregard</div> <div>B) Unclear</div> <div></div> <div>‘Clear’ = the shade and size of the line or dot are not changed with the LCD operation voltage changing .the defect looks very apparent. ‘Unclear’ = the shade and size of the line or dot are changed with the LCD operation voltage changing ,the defect looks not so apparent</div>	Minor																																												

3	Rubbing line	Not to be noticeable.	Minor
4	Allowable density	Above defects should be separated more than 10mm each other.	Minor
5	Rainbow	Not to be noticeable.	Minor
6	Dot size	To be 95% ~ 105% of the dot size (Typ.) in drawing. Partial defects of each dot (ex. pin-hole) should be treated as 'Spot'. (see <i>Screen Cosmetic Criteria (Operating) No.1</i>)	Minor
7	Uneven brightness (only back-lit type module)	<p>Uneven brightness must be $B_{MAX} / B_{MIN} \leq 2$</p> <p>- B_{MAX} : Max. value by measure in 5 points</p> <p>- B_{MIN} : Min. value by measure in 5 points</p> <p>Divide active area into 4 vertically and horizontally.</p> <p>Measure 5 points shown in the following figure.</p>  <p>O : Measuring points</p>	Minor

Note :

- (1) Size : $d = (\text{long length} + \text{short length}) / 2$
- (2) The limit samples for each item have priority.
- (3) Complex defects are defined item by item, but if the numbers of defects are defined in above table, the total number should not exceed 10.
- (4) In case of 'concentration', even the spots or the lines of 'disregarded' size should not allowed. Following three situations should be treated as 'concentration'.
 - 7 or over defects in circle of $\varnothing 5\text{mm}$.
 - 10 or over defects in circle of $\varnothing 10\text{mm}$.
 - 20 or over defects in circle of $\varnothing 20\text{mm}$.

■ PRECAUTIONS FOR USING LCD MODULES

1 Handling Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcoholDo not scrub hard to avoid damaging the display surface.
- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solventsWipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.
- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
 - To reduce the amount of static electricity generated, do not conduct assembling

and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- Do not damage or modify the pattern writing on the printed circuit board.
- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist the LCM.

2 Handling precaution for LCM

2.1 LCM is easy to be damaged. Please note below and be careful for handling.

2.2 Correct handling:

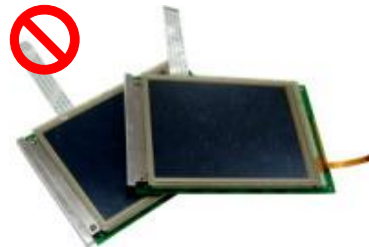


As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



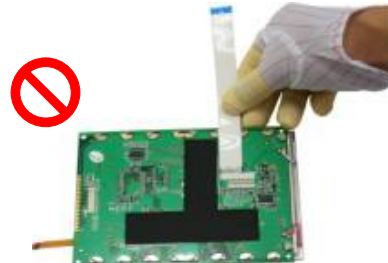
Please don't touch IC directly.



Please don't stack LCM.



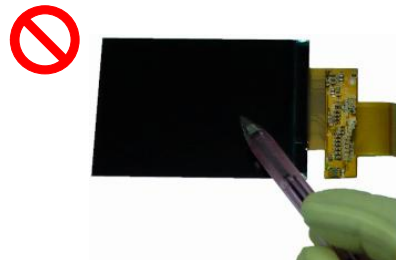
Please don't hold the surface of panel.



Please don't stretch interface of output, such as FPC cable.



Please don't hold the surface of IC.



Please don't operate with sharp stick such as pens.

3 Storage Precautions

3.1 When storing the LCD modules, the following precaution are necessary.

- 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
- 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
- 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Others

- 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 - Exposed area of the printed circuit board.
 - 3.2.3.2 -Terminal electrode sections.

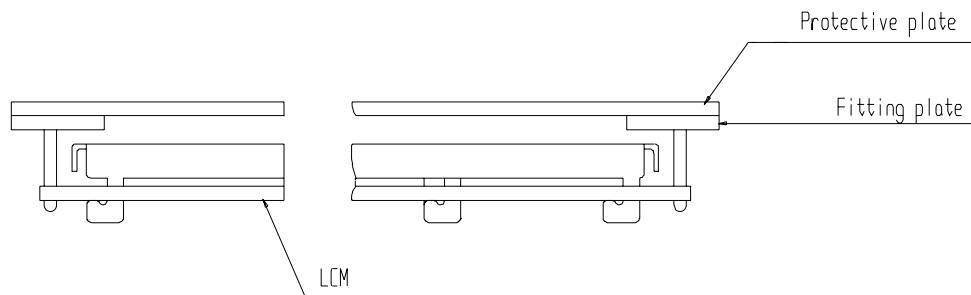
4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below.

Attend to the following items when installing the LCM.

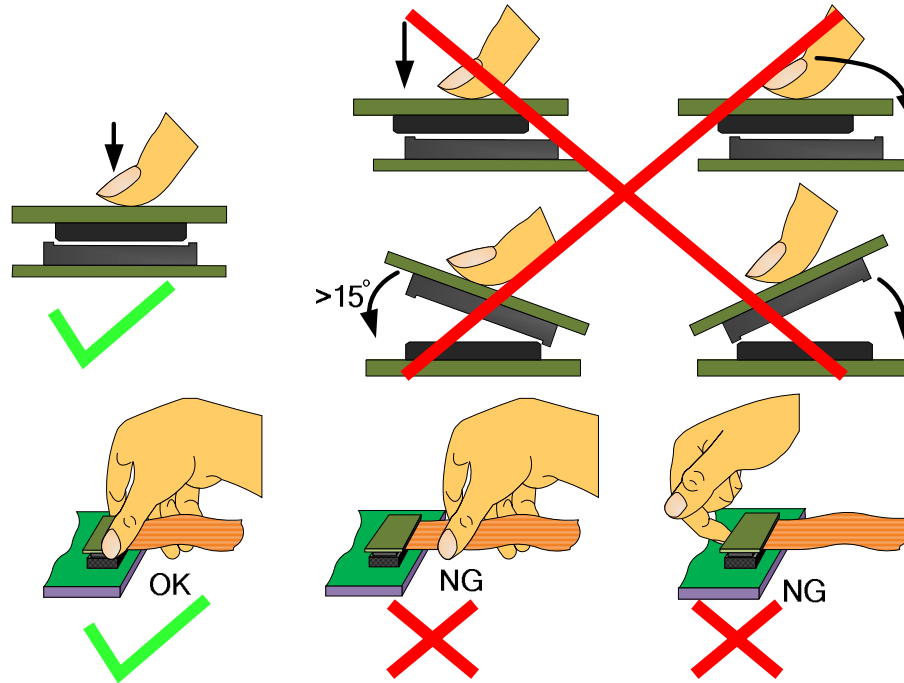
4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

4.2 Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows



4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS Product	290°C ~350°C. Time : 3-5S.	330°C ~350°C. Speed : 15-17 mm/s.	300°C ~330°C. Time : 3-6S. Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C. Time : 3-5S.	350°C ~370°C. Speed : 15-17 mm/s.	330°C ~360°C. Time : 3-6S. Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

4.6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

4.7 Return LCM under warranty

4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

4.7.1.1 - Broken LCD glass.

4.7.1.2 - PCB eyelet is damaged or modified.

4.7.1.3 - PCB conductors damaged.

4.7.1.4 - Circuit modified in any way, including addition of components.

4.7.1.5 - PCB tampered with by grinding, engraving or painting varnish.

4.7.1.6 - Soldering to or modifying the bezel in any manner.

4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- 1 For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.